

# 2SJ332(L), 2SJ332(S)

Silicon P-Channel MOS FET

**HITACHI**

November 1996

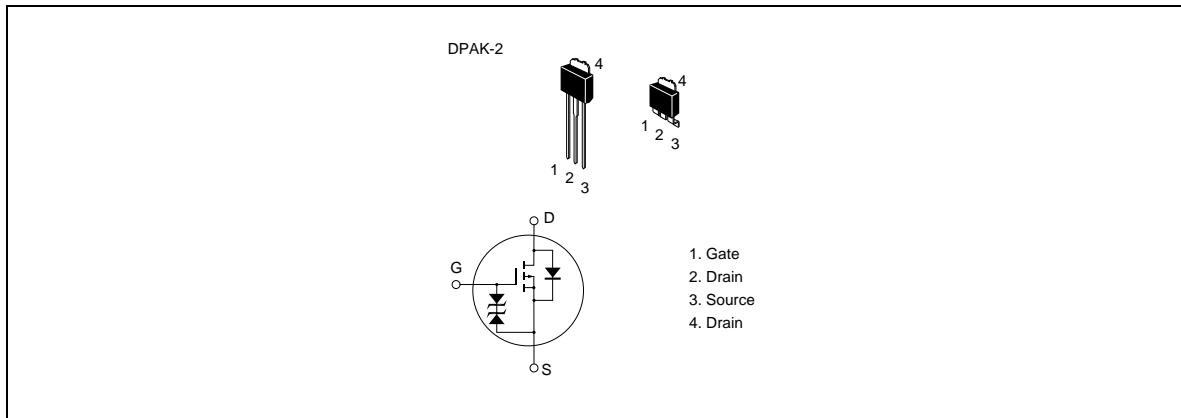
## Application

High speed power switching

## Features

- Low on-resistance
- High speed switching
- Low drive current
- 4 V gate drive device can be driven from 5 V source
- Suitable for switching regulator, DC-DC converter

## Outline



**2SJ332(L), 2SJ332(S)****Absolute Maximum Ratings (Ta = 25°C)**

Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	-20	V
Gate to source voltage	V <sub>GSS</sub>	±20	V
Drain current	I <sub>D</sub>	-10	A
Drain peak current	I <sub>D(pulse)</sub> <sup>*1</sup>	-40	A
Body to drain diode reverse drain current	I <sub>DR</sub>	-10	A
Channel dissipation	Pch <sup>*2</sup>	20	W
Channel temperature	T <sub>ch</sub>	150	°C
Storage temperature	T <sub>stg</sub>	-55 to +150	°C

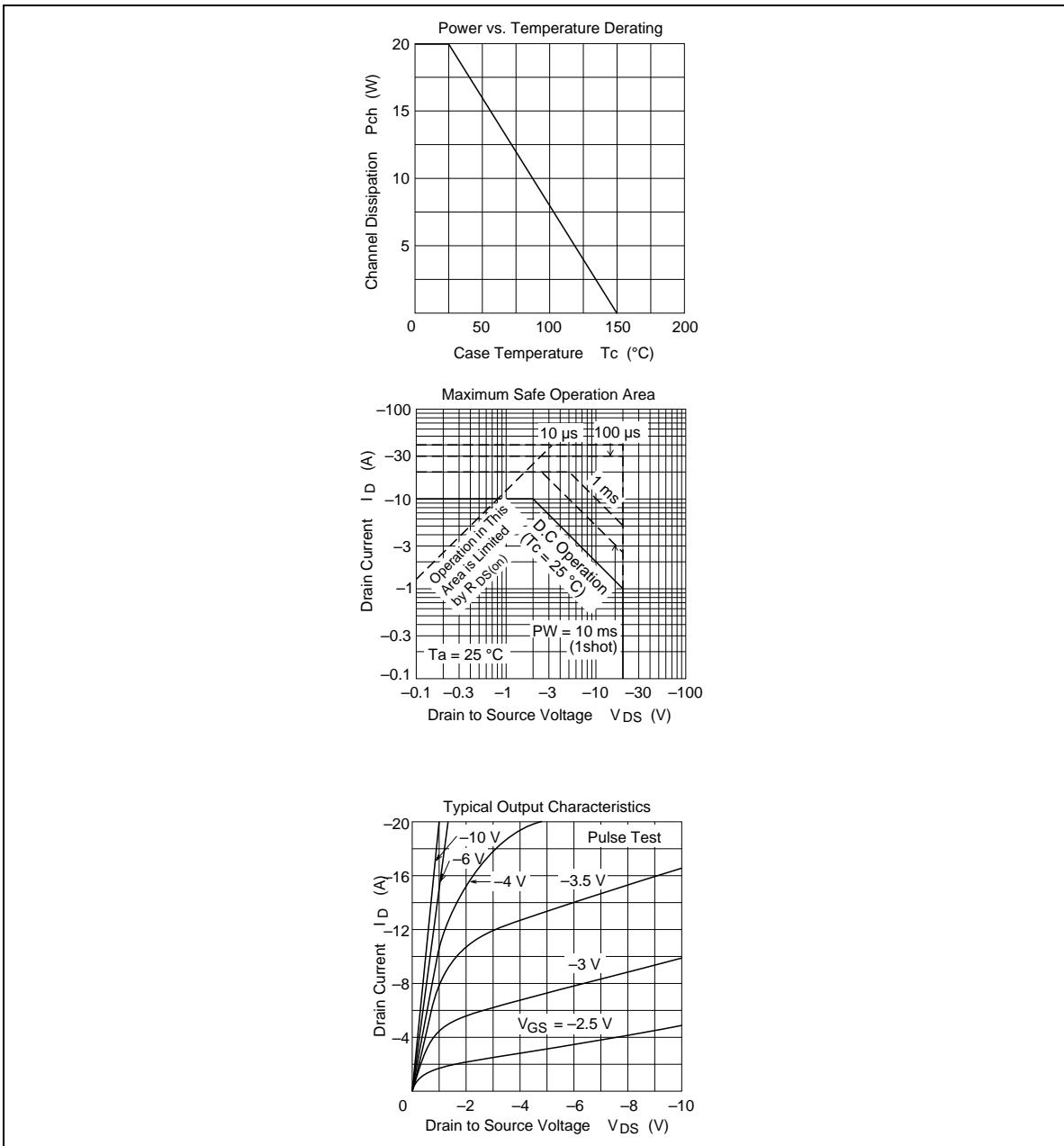
Notes 1. PW ≤ 10 µs, duty cycle ≤ 1%

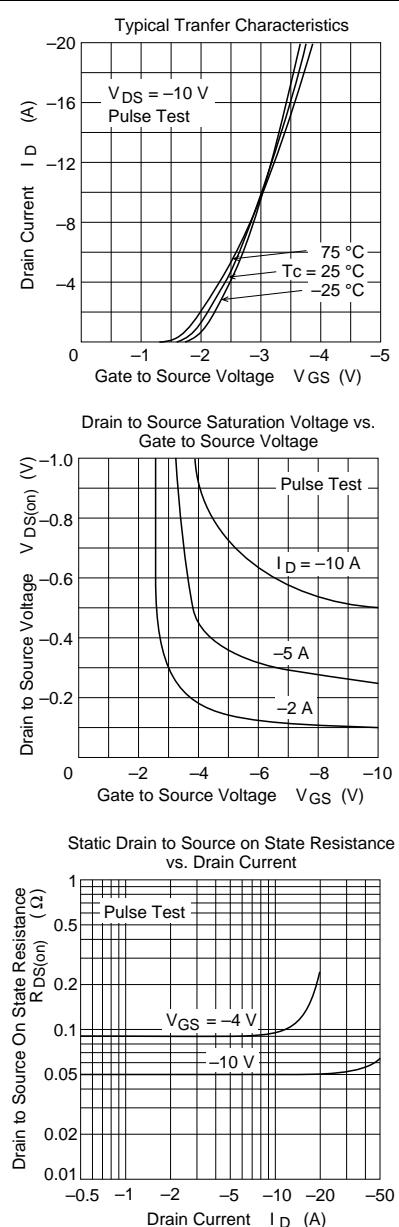
2. Value at T<sub>c</sub> = 25°C

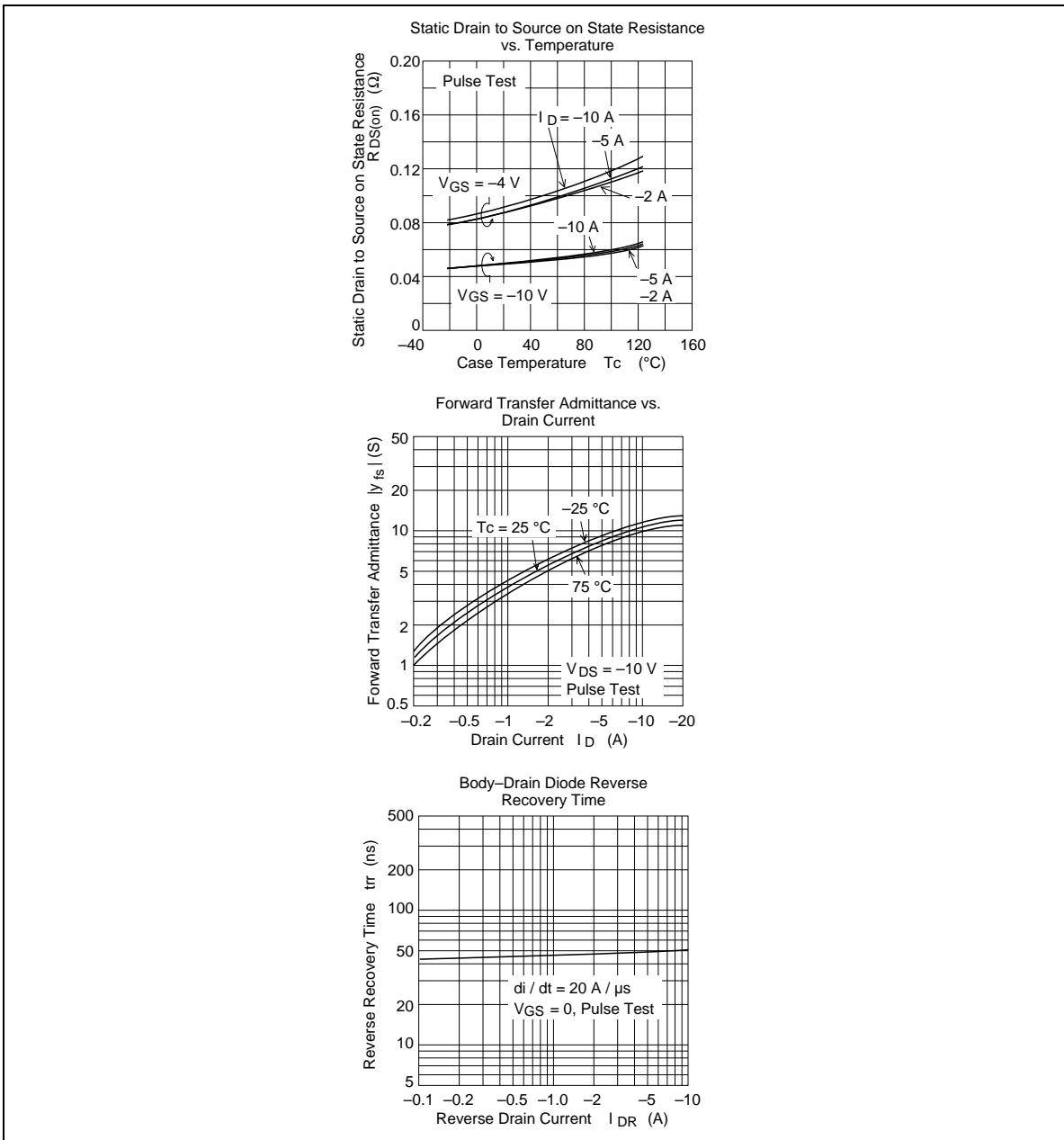
**2SJ332(L), 2SJ332(S)****Electrical Characteristics (Ta = 25°C)**

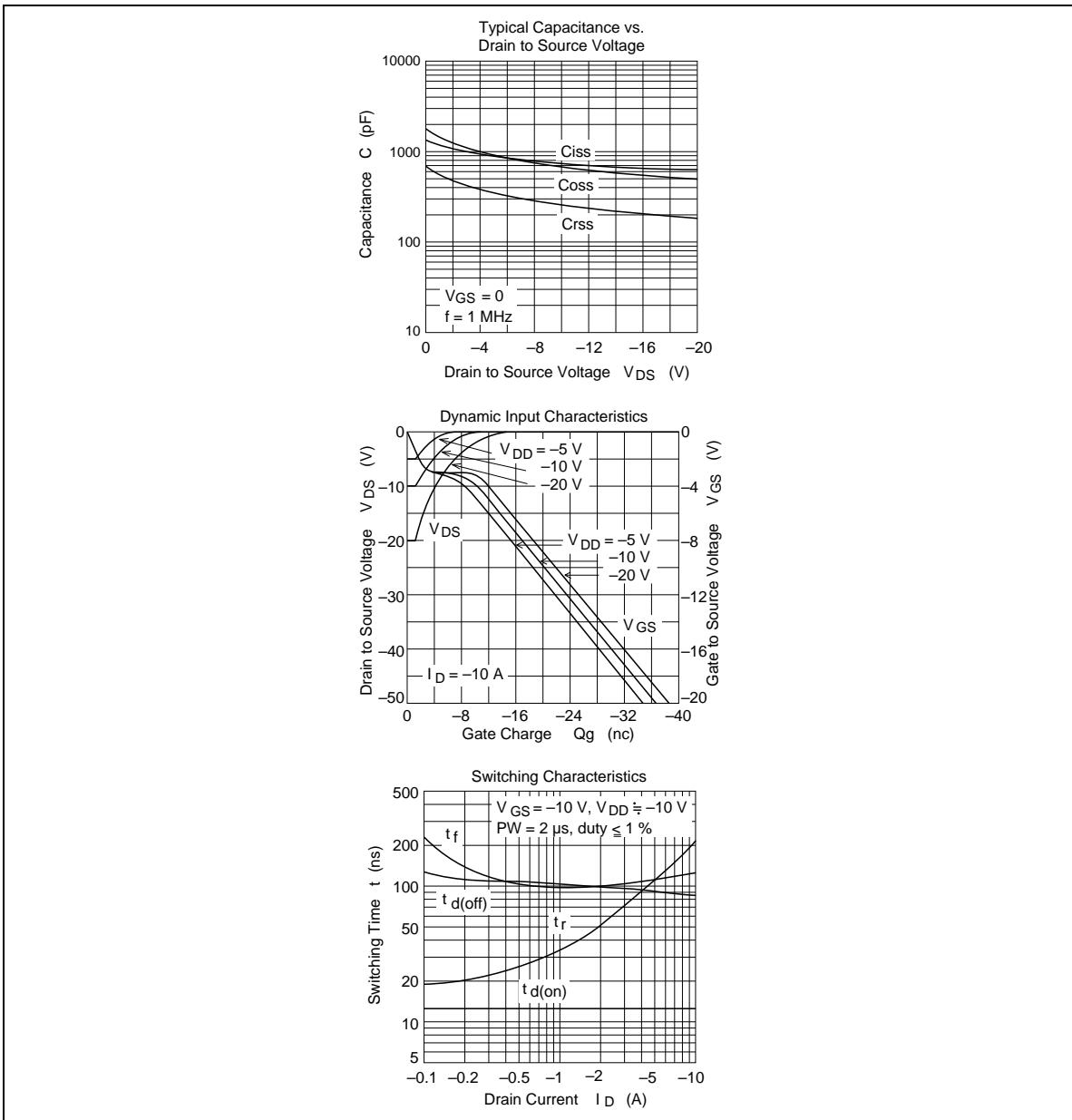
Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	V <sub>(BR)DSS</sub>	-20	—	—	V	I <sub>D</sub> = -10 mA, V <sub>GS</sub> = 0
Gate to source breakdown voltage	V <sub>(BR)GSS</sub>	±20	—	—	V	I <sub>G</sub> = ±100 μA, V <sub>DS</sub> = 0
Gate to source leak current	I <sub>GSS</sub>	—	—	±10	μA	V <sub>GS</sub> = ±16 V, V <sub>DS</sub> = 0
Zero gate voltage drain current	I <sub>DSS</sub>	—	—	-100	μA	V <sub>DS</sub> = -16 V, V <sub>GS</sub> = 0
Gate to source cutoff voltage	V <sub>GS(off)</sub>	-1.0	—	-2.5	V	I <sub>D</sub> = -1 mA, V <sub>DS</sub> = -10 V
Static drain to source on state resistance	R <sub>DS(on)</sub>	—	0.05	0.08	Ω	I <sub>D</sub> = -5 A, V <sub>GS</sub> = -10 V <sup>*1</sup>
		—	0.09	0.14	Ω	I <sub>D</sub> = -5 A, V <sub>GS</sub> = -4 V <sup>*1</sup>
Forward transfer admittance	y <sub>fs</sub>	6	9	—	S	I <sub>D</sub> = -5 A, V <sub>DS</sub> = -10 V <sup>*1</sup>
Input capacitance	C <sub>iss</sub>	—	730	—	pF	V <sub>DS</sub> = -10 V, V <sub>GS</sub> = 0, f = 1 MHz
Output capacitance	C <sub>oss</sub>	—	680	—	pF	
Reverse transfer capacitance	C <sub>rss</sub>	—	260	—	pF	
Turn-on delay time	t <sub>d(on)</sub>	—	13	—	ns	I <sub>D</sub> = -5 A, V <sub>GS</sub> = -10 V, R <sub>L</sub> = 2 Ω
Rise time	t <sub>r</sub>	—	110	—	ns	
Turn-off delay time	t <sub>d(off)</sub>	—	90	—	ns	
Fall time	t <sub>f</sub>	—	110	—	ns	
Body to drain diode forward voltage	V <sub>DF</sub>	—	-1.2	—	V	I <sub>F</sub> = -10 A, V <sub>GS</sub> = 0
Body to drain diode reverse recovery time	t <sub>rr</sub>	—	50	—	μs	I <sub>F</sub> = -10 A, V <sub>GS</sub> = 0, di <sub>F</sub> /dt = 50 A/μs

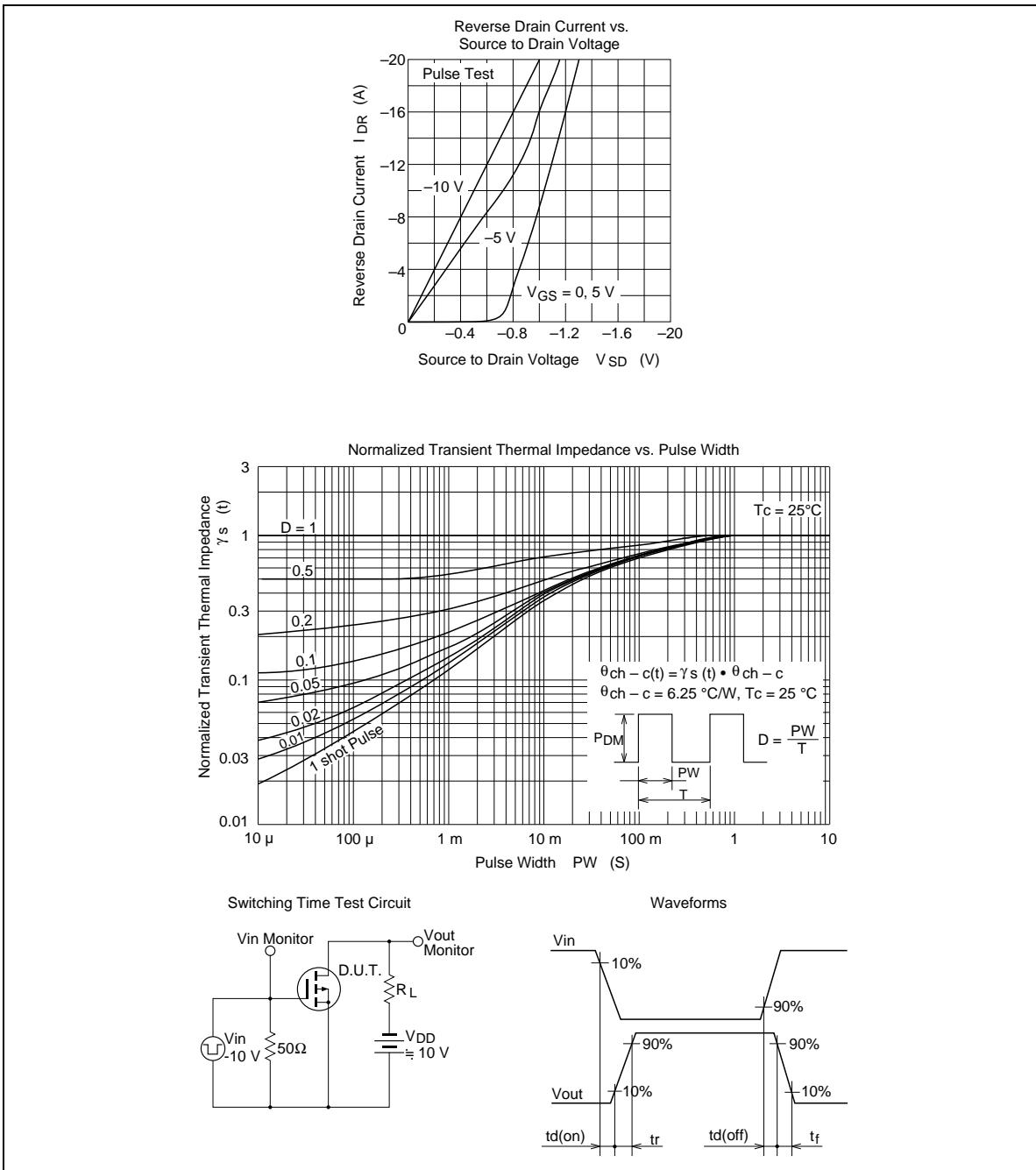
Note 1. Pulse test

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## **2SJ332(L), 2SJ332(S)**

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